

# Dual JK flip-flop with set and reset; positive-edge trigger

# 74LV109

## FEATURES

- Optimized for low voltage applications: 1.0 to 3.6 V
- Accepts TTL input levels between  $V_{CC} = 2.7$  V and  $V_{CC} = 3.6$  V
- Typical  $V_{OLP}$  (output ground bounce)  $< 0.8$  V at  $V_{CC} = 3.3$  V,  $T_{amb} = 25^{\circ}\text{C}$
- Typical  $V_{OHV}$  (output  $V_{OH}$  undershoot)  $> 2$  V at  $V_{CC} = 3.3$  V,  $T_{amb} = 25^{\circ}\text{C}$
- Output capability: standard
- $I_{CC}$  category: flip-flops

## DESCRIPTION

The 74LV109 is a low-voltage Si-gate CMOS device that is pin and function compatible with 74HC/HCT109.

The 74LV109 is a dual positive-edge triggered JK-type flip-flop featuring individual J,  $\bar{K}$  inputs, clock (CP) inputs, set ( $\bar{S}_D$ ) and reset ( $\bar{R}_D$ ) inputs; also complementary Q and  $\bar{Q}$  outputs.

The set and reset are asynchronous active LOW inputs and operate independently of the clock input.

The J and  $\bar{K}$  inputs control the state changes of the flip-flops as described in the mode select function table. The J and  $\bar{K}$  inputs must be stable one set-up time prior to the LOW-to-HIGH clock transition for predictable operation.

The JK design allows operation as a D-type flip-flop by tying the J and  $\bar{K}$  inputs together.

Schmitt-trigger action in the clock input makes the circuit highly tolerant to slower clock rise and fall times.

## QUICK REFERENCE DATA

GND = 0 V;  $T_{amb} = 25^{\circ}\text{C}$ ;  $t_r = t_f \leq 2.5$  ns

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
$t_{PHL}/t_{PLH}$	Propagation delay nCP to nQ, n $\bar{Q}$ n $\bar{S}_D$ to nQ, n $\bar{Q}$ n $\bar{R}_D$ to nQ, n $\bar{Q}$	$C_L = 15$ pF; $V_{CC} = 3.3$ V	14 12 12	ns
$f_{max}$	Maximum clock frequency		77	MHz
$C_I$	Input capacitance		3.5	pF
$C_{PD}$	Power dissipation capacitance per flip-flop	$V_I = \text{GND to } V_{CC}^1$	20	pF

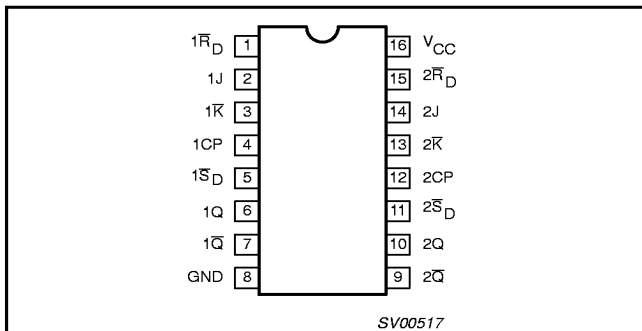
### NOTE:

- $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu\text{W}$ )  
 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:  
 $f_i$  = input frequency in MHz;  $C_L$  = output load capacitance in pF;  
 $f_o$  = output frequency in MHz;  $V_{CC}$  = supply voltage in V;  
 $\Sigma (C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.

## ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
16-Pin Plastic DIL	-40°C to +125°C	74LV109 N	74LV109 N	SOT38-4
16-Pin Plastic SO	-40°C to +125°C	74LV109 D	74LV109 D	SOT109-1
16-Pin Plastic SSOP Type II	-40°C to +125°C	74LV109 DB	74LV109 DB	SOT338-1
16-Pin Plastic TSSOP Type I	-40°C to +125°C	74LV109 PW	74LV109PW DH	SOT403-1

## PIN CONFIGURATION



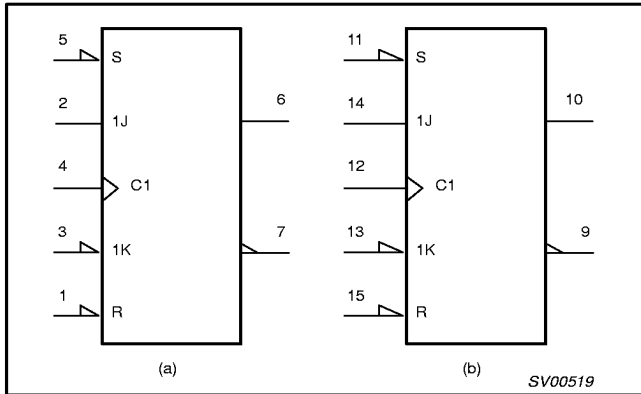
## PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION
1, 15	$1\bar{R}_D, 2\bar{R}_D$	Asynchronous reset input (active LOW)
2, 14, 3, 13	$1J, 2J, 1\bar{K}, 2\bar{K}$	Synchronous inputs; flip-flops 1 and 2
4, 12	$1CP, 2CP$	Clock input (LOW-to-HIGH, edge-triggered)
5, 11	$1\bar{S}_D, 2\bar{S}_D$	Asynchronous set inputs (active LOW)
6, 10	$1Q, 2Q$	True flip-flop outputs
7, 9	$1\bar{Q}, 2\bar{Q}$	Complement flip-flop outputs
8	GND	Ground (0 V)
16	$V_{CC}$	Positive supply voltage

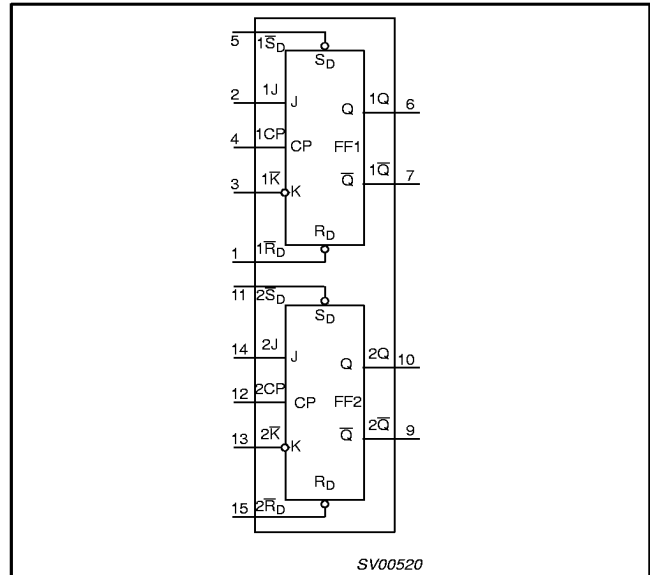
# Dual JK flip-flop with set and reset; positive-edge trigger

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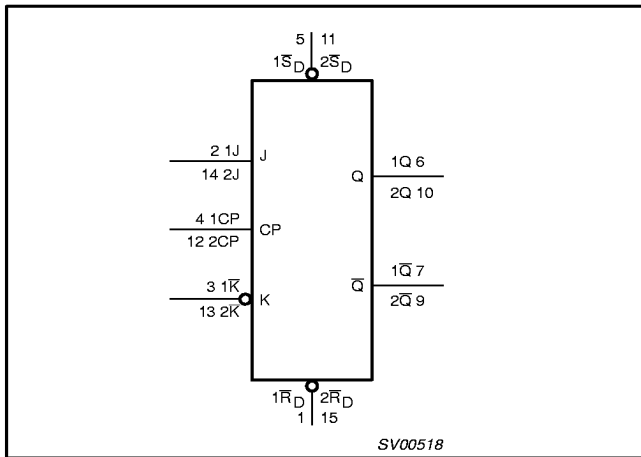
## LOGIC SYMBOL (IEEE/IEC)



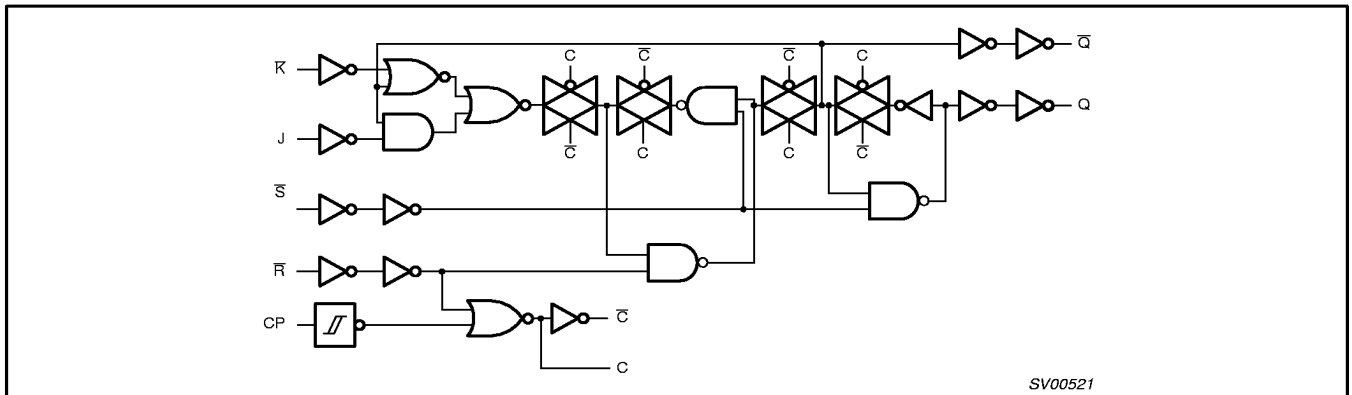
## FUNCTIONAL DIAGRAM



## LOGIC SYMBOL



## LOGIC DIAGRAM



## Dual JK flip-flop with set and reset; positive-edge trigger

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## FUNCTION TABLE

OPERATING MODES	INPUTS					OUTPUTS	
	nS <sub>D</sub>	nR <sub>D</sub>	nCP	nJ	nK	nQ	nQ̄
Asynchronous set	L	H	X	X	X	H	L
Asynchronous reset	H	L	X	X	X	L	H
Undetermined	L	L	X	X	X	H	H
Toggle	H	H	↑	h	l	q̄	q
Load "0" (reset)	H	H	↑	l	l	L	H
Load "1" (set)	H	H	↑	h	h	H	L
Hold "no change"	H	H	↑	l	h	q	q̄

## NOTES:

H = HIGH voltage level

h = HIGH voltage level one set-up time prior to the LOW-to-HIGH CP transition

L = LOW voltage level

l = LOW voltage level one set-up time prior to the LOW-to-HIGH CP transition

q = lower case letters indicate the state of the referenced output one set-up time prior to the LOW-to-HIGH CP transition.

X = don't care

↑ = LOW-to-HIGH CP transition

## RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP.	MAX	UNIT
V <sub>CC</sub>	DC supply voltage	See Note 1	1.0	3.3	3.6	V
V <sub>I</sub>	Input voltage		0	–	V <sub>CC</sub>	V
V <sub>O</sub>	Output voltage		0	–	V <sub>CC</sub>	V
T <sub>amb</sub>	Operating ambient temperature range in free air	See DC and AC characteristics	-40		+85	°C
t <sub>r</sub> , t <sub>f</sub>	Input rise and fall times except for Schmitt-trigger inputs	V <sub>CC</sub> = 1.0V to 2.0V V <sub>CC</sub> = 2.0V to 2.7V V <sub>CC</sub> = 2.7V to 3.6V	–	–	500 200 100	ns/V

## NOTE:

1. The LV is guaranteed to function down to V<sub>CC</sub> = 1.0V (input levels GND or V<sub>CC</sub>); DC characteristics are guaranteed from V<sub>CC</sub> = 1.2V to V<sub>CC</sub> = 3.6V.ABSOLUTE MAXIMUM RATINGS<sup>1, 2</sup>

In accordance with the Absolute Maximum Rating System (IEC 134).

Voltages are referenced to GND (ground = 0V).

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V <sub>CC</sub>	DC supply voltage		-0.5 to +4.6	V
±I <sub>IK</sub>	DC input diode current	V <sub>I</sub> < -0.5 or V <sub>I</sub> > V <sub>CC</sub> + 0.5V	20	mA
±I <sub>OK</sub>	DC output diode current	V <sub>O</sub> < -0.5 or V <sub>O</sub> > V <sub>CC</sub> + 0.5V	50	mA
±I <sub>O</sub>	DC output source or sink current – standard outputs	-0.5V < V <sub>O</sub> < V <sub>CC</sub> + 0.5V	25	mA
±I <sub>GND</sub> , ±I <sub>CC</sub>	DC V <sub>CC</sub> or GND current for types with – standard outputs		50	mA
T <sub>stg</sub>	Storage temperature range		-65 to +150	°C
P <sub>TOT</sub>	Power dissipation per package – plastic DIL – plastic mini-pack (SO) – plastic shrink mini-pack (SSOP and TSSOP)	for temperature range: -40 to +125°C above +70°C derate linearly with 12 mW/K above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	750 500 400	mW

## NOTE:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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**DC ELECTRICAL CHARACTERISTICS**

Over recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS					UNIT
			-40°C to +85°C			-40°C to +125°C		
			MIN	TYP <sup>1</sup>	MAX	MIN	MAX	
V <sub>IH</sub>	HIGH level Input voltage	V <sub>CC</sub> = 1.2 V	0.9			0.9		V
		V <sub>CC</sub> = 2.0 V	1.4			1.4		
		V <sub>CC</sub> = 2.7 to 3.6 V	2.0			2.0		
V <sub>IL</sub>	LOW level Input voltage	V <sub>CC</sub> = 1.2 V			0.3		0.3	V
		V <sub>CC</sub> = 2.0 V			0.6		0.6	
		V <sub>CC</sub> = 2.7 to 3.6 V			0.8		0.8	
V <sub>OH</sub>	HIGH level output voltage; all outputs	V <sub>CC</sub> = 1.2 V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; -I <sub>O</sub> = 100µA		1.2				V
		V <sub>CC</sub> = 2.0 V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; -I <sub>O</sub> = 100µA	1.8	2.0		1.8		
		V <sub>CC</sub> = 2.7 V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; -I <sub>O</sub> = 100µA	2.5	2.7		2.5		
		V <sub>CC</sub> = 3.0 V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; -I <sub>O</sub> = 100µA	2.8	3.0		2.8		
V <sub>OH</sub>	HIGH level output voltage; STANDARD outputs	V <sub>CC</sub> = 3.0 V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; -I <sub>O</sub> = 6mA	2.40	2.82		2.20		V
V <sub>OL</sub>	LOW level output voltage; all outputs	V <sub>CC</sub> = 1.2 V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; I <sub>O</sub> = 100µA		0				V
		V <sub>CC</sub> = 2.0 V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; I <sub>O</sub> = 100µA		0	0.2		0.2	
		V <sub>CC</sub> = 2.7 V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; I <sub>O</sub> = 100µA		0	0.2		0.2	
		V <sub>CC</sub> = 3.0 V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; I <sub>O</sub> = 100µA		0	0.2		0.2	
V <sub>OL</sub>	LOW level output voltage; STANDARD outputs	V <sub>CC</sub> = 3.0 V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; I <sub>O</sub> = 6mA		0.25	0.40		0.50	V
I <sub>I</sub>	Input leakage current	V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = V <sub>CC</sub> or GND			1.0		1.0	µA
I <sub>CC</sub>	Quiescent supply current; flip-flops	V <sub>CC</sub> = 3.6V; V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0			20.0		80	µA
ΔI <sub>CC</sub>	Additional quiescent supply current per input	V <sub>CC</sub> = 2.7 V to 3.6 V; V <sub>I</sub> = V <sub>CC</sub> - 0.6 V			500		850	µA

**NOTE:**1. All typical values are measured at T<sub>amb</sub> = 25°C.**AC CHARACTERISTICS**GND = 0V; t<sub>r</sub> = t<sub>f</sub> ≤ 2.5ns; C<sub>L</sub> = 50pF; R<sub>L</sub> = 1KΩ

SYMBOL	PARAMETER	WAVEFORM	CONDITION	LIMITS					UNIT
				-40 to +85 °C			-40 to +125 °C		
				MIN	TYP <sup>1</sup>	MAX	MIN	MAX	
t <sub>PHL</sub> /t <sub>PLH</sub>	Propagation delay nCP to nQ, nQ̄	Figure 1	V <sub>CC</sub> (V)						ns
			1.2		90				
			2.0		31	58		70	
			2.7		23	43		51	
			3.0 to 3.6		18 <sup>2</sup>	34		41	
t <sub>PLH</sub>	Propagation delay nS <sub>D</sub> to nQ	Figure 2	V <sub>CC</sub> (V)						ns
			1.2		55				
			2.0		19	36		44	
			2.7		14	26		33	
			3.0 to 3.6		10 <sup>2</sup>	21		26	

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**AC CHARACTERISTICS (Continued)**GND = 0V;  $t_r = t_f \leq 2.5\text{ns}$ ;  $C_L = 50\text{pF}$ ;  $R_L = 1\text{K}\Omega$ 

SYMBOL	PARAMETER	WAVEFORM	CONDITION	LIMITS					UNIT
				-40 to +85 °C			-40 to +125 °C		
				V <sub>CC</sub> (V)	MIN	TYP <sup>1</sup>	MAX	MIN	
t <sub>PHL</sub>	Propagation delay nS <sub>D</sub> to nQ	Figure 2	1.2		75				ns
			2.0		26	46		60	
			2.7		19	36		44	
			3.0 to 3.6		17 <sup>2</sup>	29		35	
t <sub>PHL</sub>	Propagation delay nR <sub>D</sub> to nQ	Figure 2	1.2		75				ns
			2.0		26	46		60	
			2.7		19	36		44	
			3.0 to 3.6		15 <sup>2</sup>	29		35	
t <sub>PLH</sub>	Propagation delay nR <sub>D</sub> to nQ	Figure 2	1.2		70				ns
			2.0		24	44		54	
			2.7		18	33		40	
			3.0 to 3.6		13 <sup>2</sup>	26		32	
t <sub>w</sub>	Clock pulse width HIGH or LOW	Figure 1	2.0	34	12		41		ns
			2.7	25	9		30		
			3.0 to 3.6	20	7 <sup>2</sup>		24		
t <sub>w</sub>	Set or reset pulse width HIGH or LOW	Figure 2	2.0	34	9		41		ns
			2.7	25	6		30		
			3.0 to 3.6	20	5 <sup>2</sup>		24		
t <sub>rem</sub>	Removal time nS <sub>D</sub> , nR <sub>D</sub> to nCP	Figure 2	1.2		35				ns
			2.0	24	12		29		
			2.7	18	9		21		
			3.0 to 3.6	14	7 <sup>2</sup>		17		
t <sub>su</sub>	Set-up time nJ, nK to CP	Figure 1	1.2		30				ns
			2.0	22	10		26		
			2.7	16	8		19		
			3.0 to 3.6	13	6 <sup>2</sup>		15		
t <sub>h</sub>	Hold time nJ, nK to nCP	Figure 1	1.2		-5				ns
			2.0	5	-2		5		
			2.7	5	-1		5		
			3.0 to 3.6	5	0 <sup>2</sup>		5		
f <sub>max</sub>	Maximum clock pulse frequency	Figure 1	2.0	14	40		12		MHz
			2.7	19	58		16		
			3.0 to 3.6	24	70 <sup>2</sup>		20		

**NOTES:**

1. Unless otherwise stated, all typical values are measured at T<sub>amb</sub> = 25°C
2. Typical values are measured at V<sub>CC</sub> = 3.3 V.

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## AC WAVEFORMS

$V_M = 1.5\text{ V}$  at  $V_{CC} \geq 2.7\text{ V}$ ;  
 $V_M = 0.5 \times V_{CC}$  at  $V_{CC} < 2.7\text{ V}$ ;  
 $V_{OL}$  and  $V_{OH}$  are the typical output voltage drop that occur with the output load.

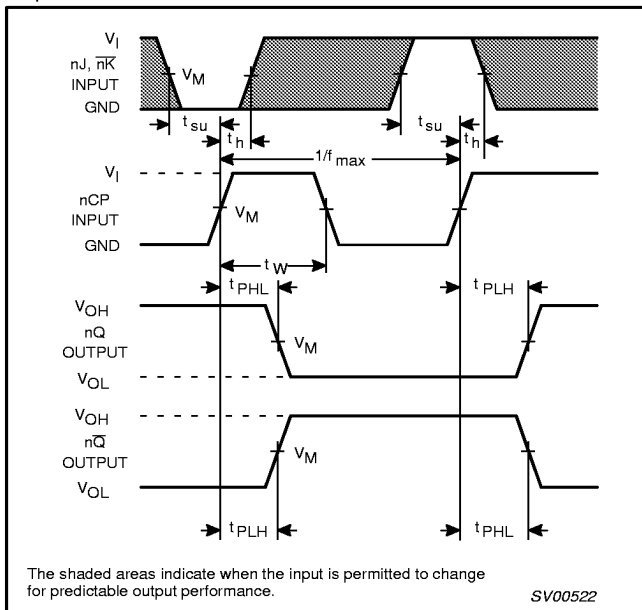


Figure 1. Clock (nCP) to output (nQ, nQ-bar) propagation delays, the clock pulse width, the nJ and nK to nCP set-up, the nCP to nJ, nK hold times and the maximum clock pulse frequency.

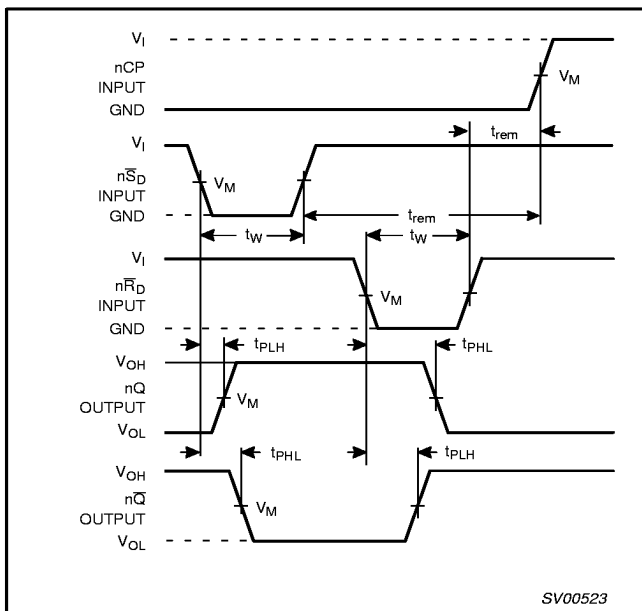


Figure 2. Set (nSD) and reset (nRD) input to output (nQ, nQ-bar) propagation delays, the set and reset pulse widths and the nRD, nSD to nCP removal time.

## TEST CIRCUIT

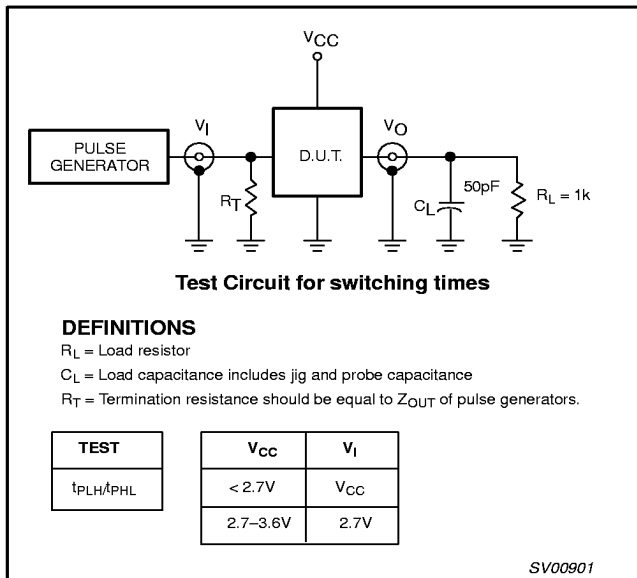


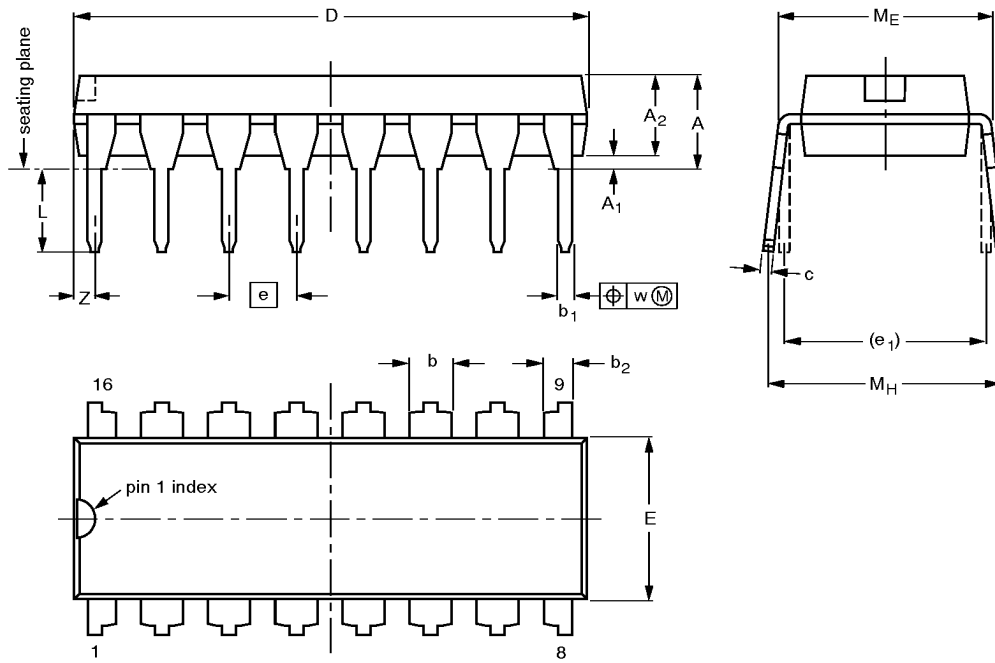
Figure 3. Load circuitry for switching times.

Dual JK flip-flop with set and reset; positive-edge trigger

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DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	b <sub>2</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	e <sub>1</sub>	L	M <sub>E</sub>	M <sub>H</sub>	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.030

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

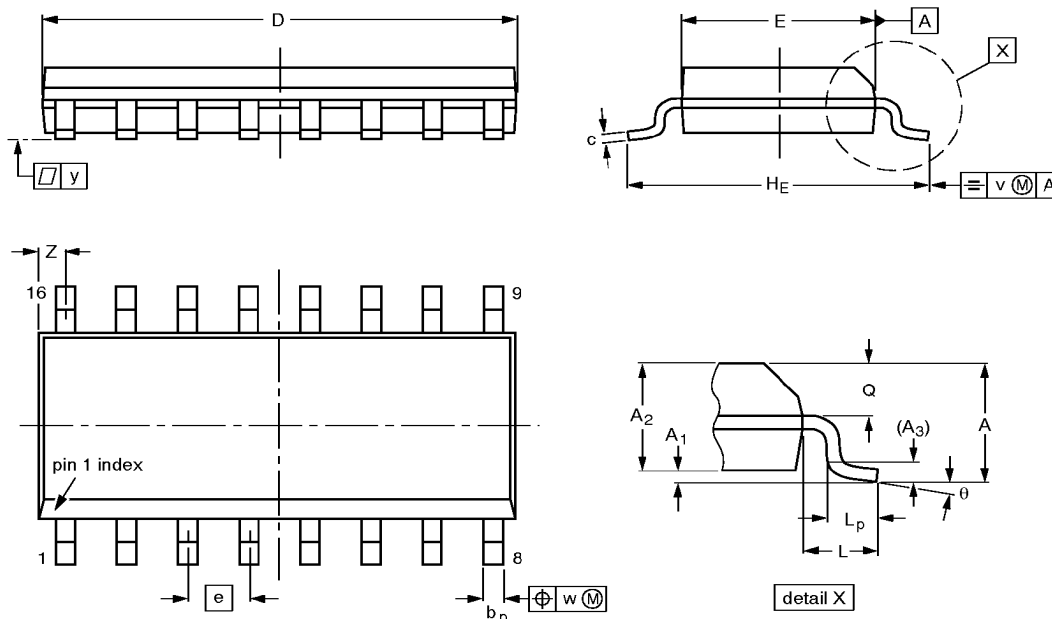
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT38-4						92-11-17 95-01-14

# Dual JK flip-flop with set and reset; positive-edge trigger

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SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



**DIMENSIONS (inch dimensions are derived from the original mm dimensions)**

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	Z <sup>(1)</sup>	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8° 0°
inches	0.069	0.0098 0.0039	0.057 0.049	0.01	0.019 0.014	0.0098 0.0075	0.39 0.38	0.16 0.15	0.050	0.24 0.23	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	

**Note**

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES			EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ		
SOT109-1	076E07S	MS-012AC			91-08-13 95-01-23

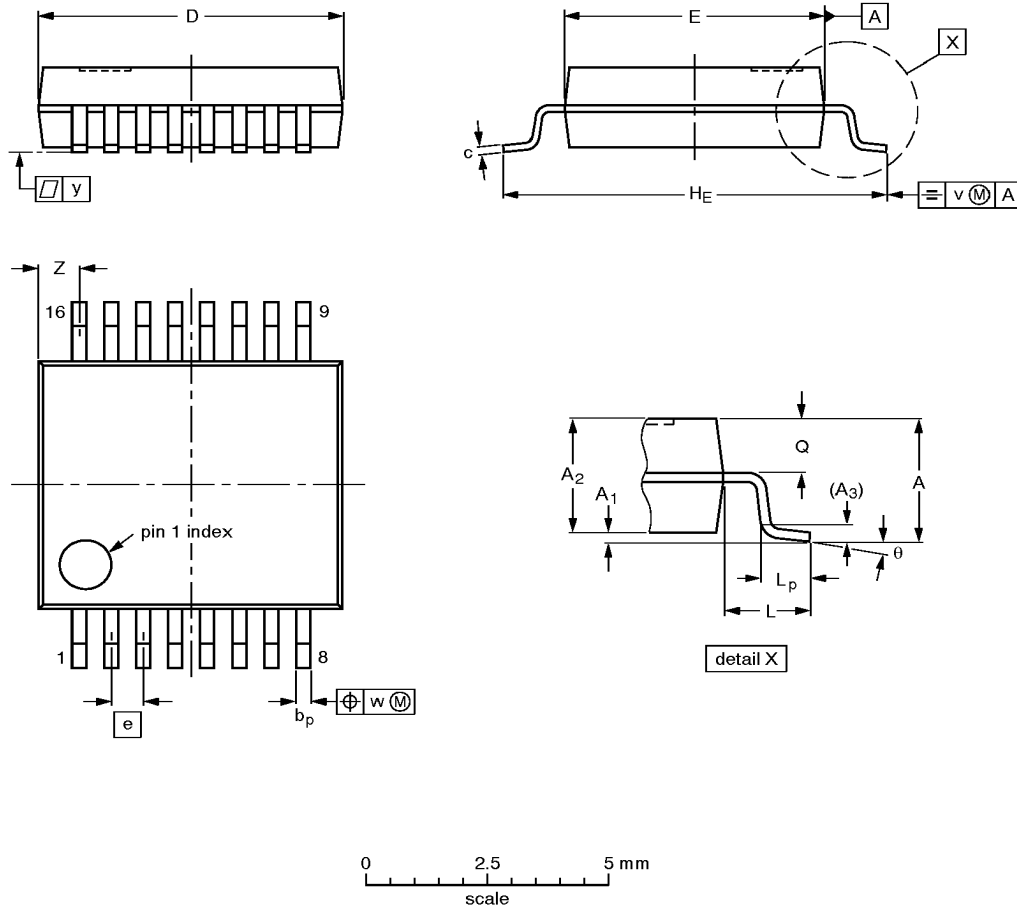


Dual JK flip-flop with set and reset; positive-edge trigger

74LV109

SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	Z <sup>(1)</sup>	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.00 0.55	8° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

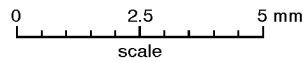
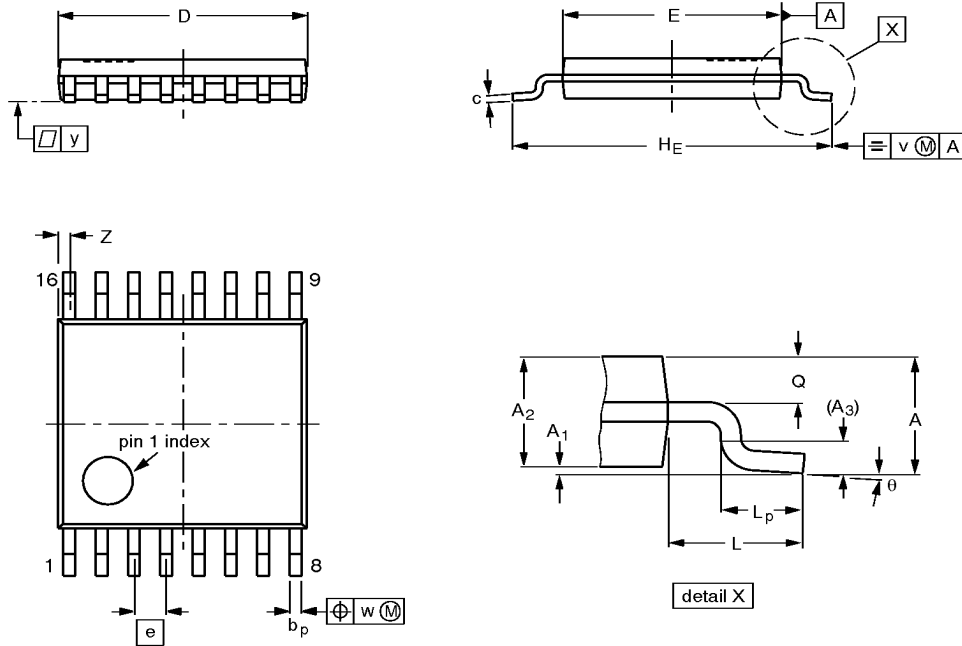
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT338-1		MO-150AC				94-01-14 95-02-04

Dual JK flip-flop with set and reset; positive-edge trigger

74LV109

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(2)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	Z <sup>(1)</sup>	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8° 0°

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT403-1		MO-153				-94-07-12 95-04-04